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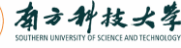
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**IEEE****IEEE ICMA 2026**

**2026 IEEE International Conference on
Mechatronics and Automation
August 2-5, 2026, Changchun, China**



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Call for Papers

The 2026 IEEE International Conference on Mechatronics and Automation (ICMA 2026) will take place in Changchun, China from August 2 to August 5, 2026. A renowned ancient city in China, Changchun is situated in northeastern China. As the capital of Jilin province, Changchun is known as the cradle of new China's automobile industry, optoelectronics technology and biological technology, applied chemistry and so on. As the host city of IEEE ICMA 2026, Changchun not only provides the attendees with a great venue for this event, but also an unparalleled experience in Chinese history and culture. You are cordially invited to join us at IEEE ICMA 2026 in Changchun to live this unique experience. The objective of IEEE ICMA 2026 is to provide a forum for researchers, educators, engineers, and government officials involved in the general areas of mechatronics, robotics, automation and sensors to disseminate their latest research results and exchange views on the future research directions of these fields.

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Organized Sessions: Proposals with the title, the organizers, and a brief statement of purpose of the session must be submitted to an OS Chair by April 10, 2026.

Tutorials & Workshops: Proposals for tutorials and workshops that address related topics must be submitted to one of the Tutorial/Workshop Chairs by May 1, 2026.

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